

APPLICATION TRANSMITTAL

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U.S. PTO
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Customer No. 20350
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86/07/60

PATENT APPLICATION
ASSISTANT COMMISSIONER FOR PATENTS
Washington, D. C. 20231

Sir:

Transmitted herewith for filing is the [X] patent application, [] design patent application, [] continuation-in-part patent application of

Inventor(s): Daniel L. Flamm

For: MULTI-TEMPERATURE PLASMA ETCHING PROCESS

[X] This application claims priority from each of the following Application Nos./filing dates:

60/058,650 / 9/11/97 ; 08/567,224 / 12/4/95 ; _____ / _____

[] Please amend this application by adding the following before the first sentence: --This application claims the benefit of U.S. Provisional Application No. 60/_____, filed _____, the disclosure of which is incorporated by reference.--

Enclosed are:

[X] Patent Application (incl. 30 pages spec., 3 pages claims, 1 page abstract).

[X] 15 sheet(s) of [] formal [X] informal drawing(s).

[] An assignment of the invention to _____.

[] A [] signed [] unsigned Declaration & Power of Attorney.

[] A verified statement to establish small entity status under 37 CFR 1.9 and 37 CFR 1.27 [] is enclosed [] was filed in the earliest of the above-identified patent application(s).

[] A certified copy of a _____ application.

[] Information Disclosure Statement under 37 CFR 1.97.

[] A petition to extend time to respond in the parent application of this continuation-in-part application.

[X] Postcard.

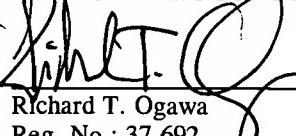
Pursuant to 37 CFR 1.53(d), Applicant requests deferral of the filing fee until submission of the Missing Parts of Application.

DO NOT CHARGE THE FILING FEE AT THIS TIME.

2 extra copies of this sheet are enclosed.

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1665518-1app.trn

Respectfully submitted,
TOWNSEND and TOWNSEND and CREW LLP


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